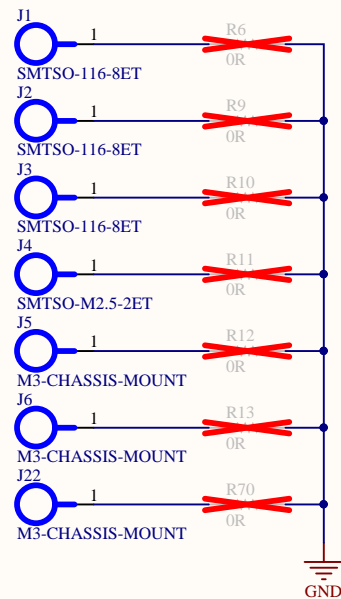
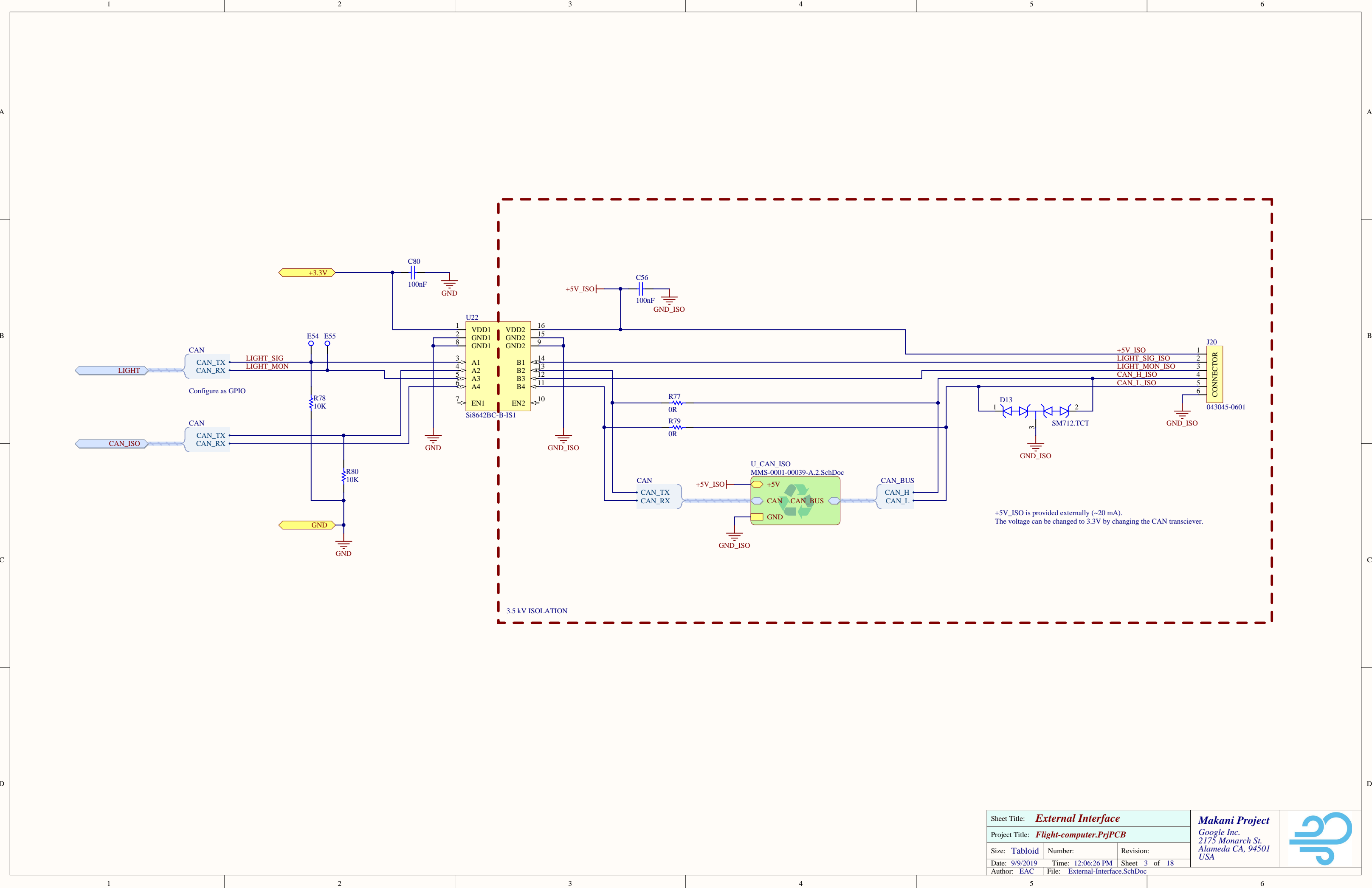
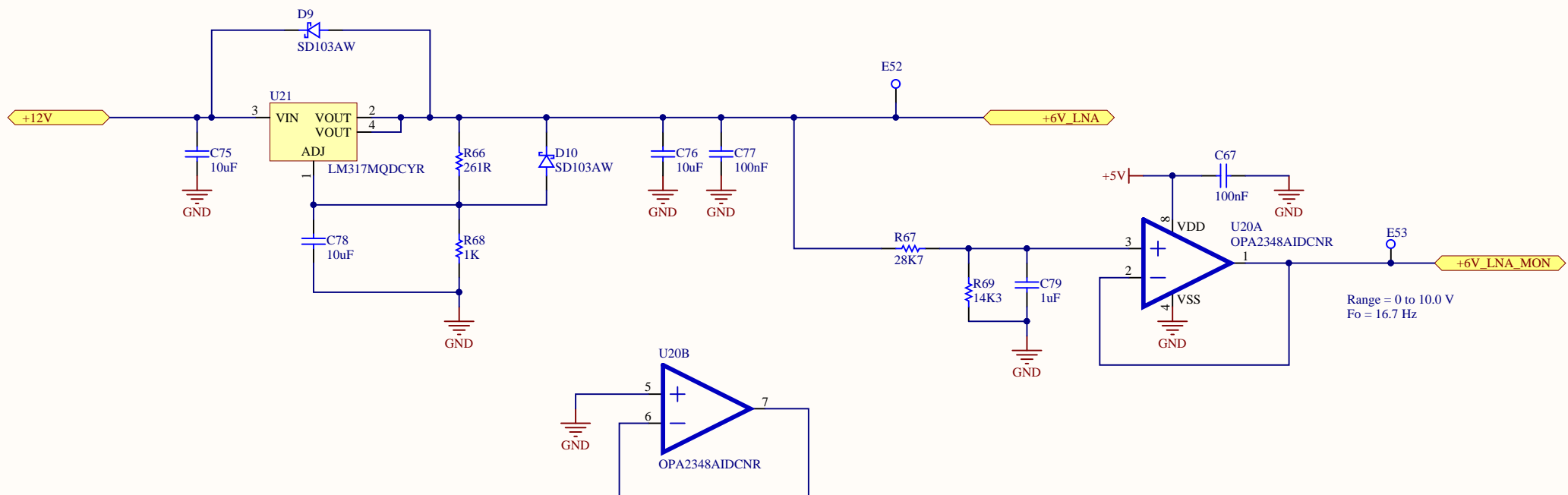
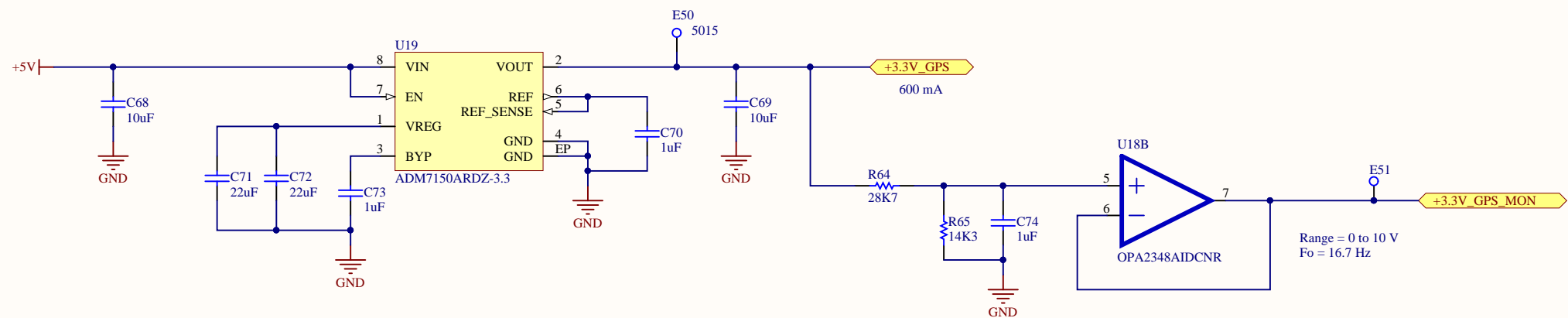
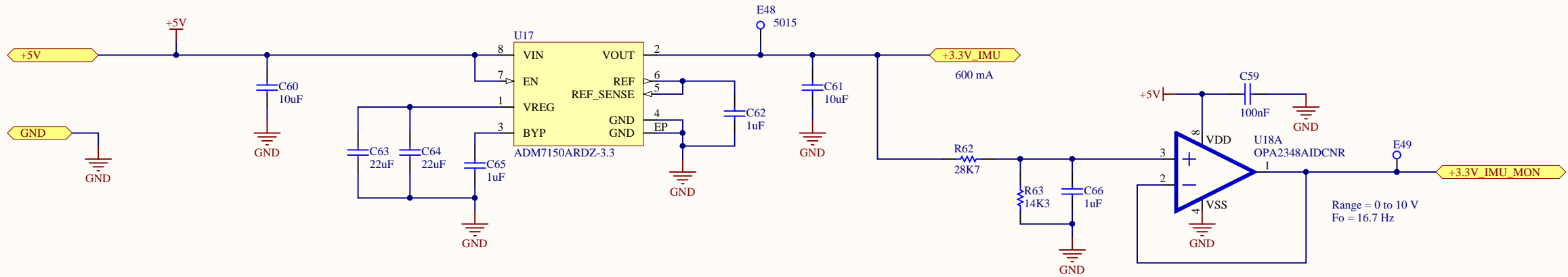
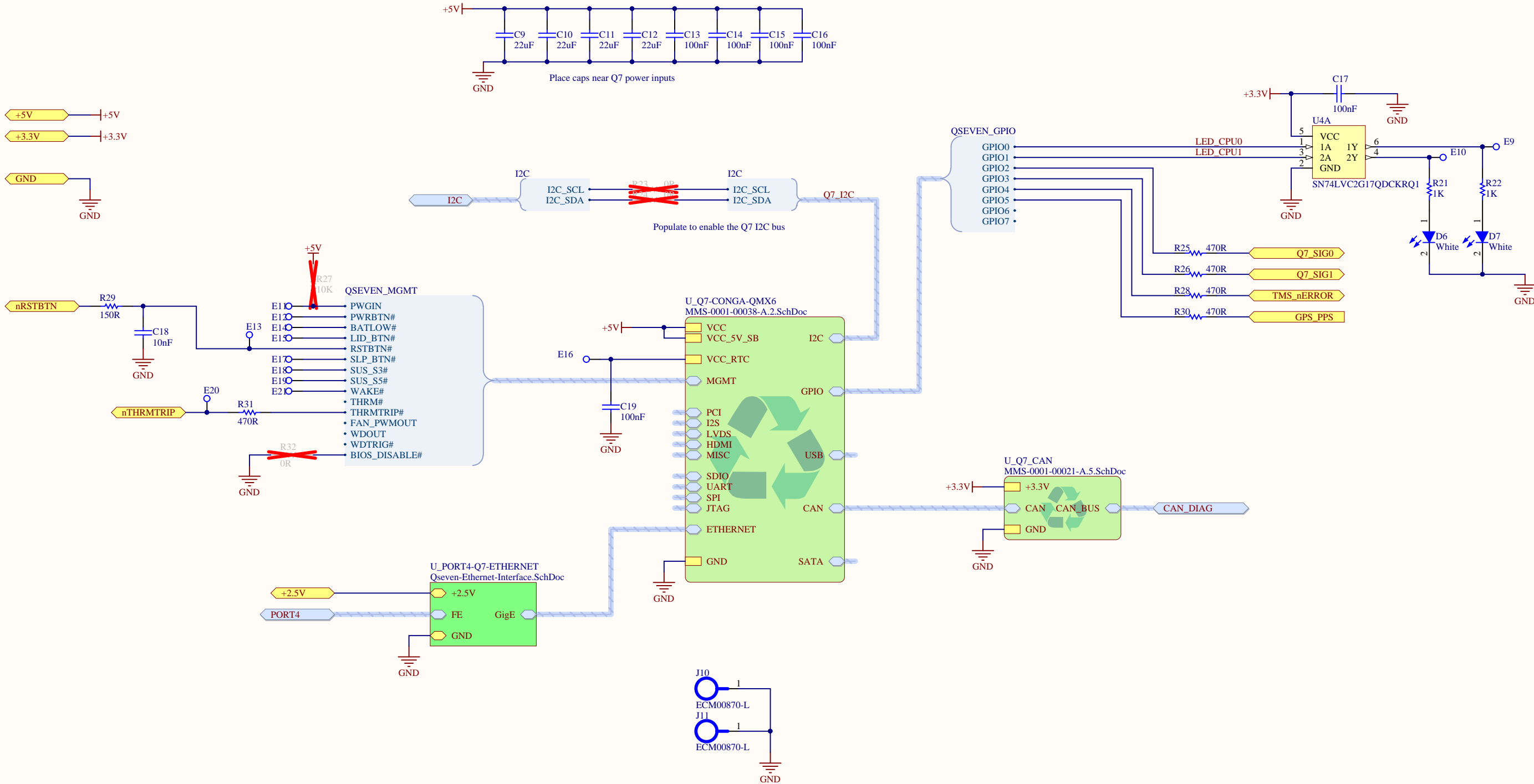


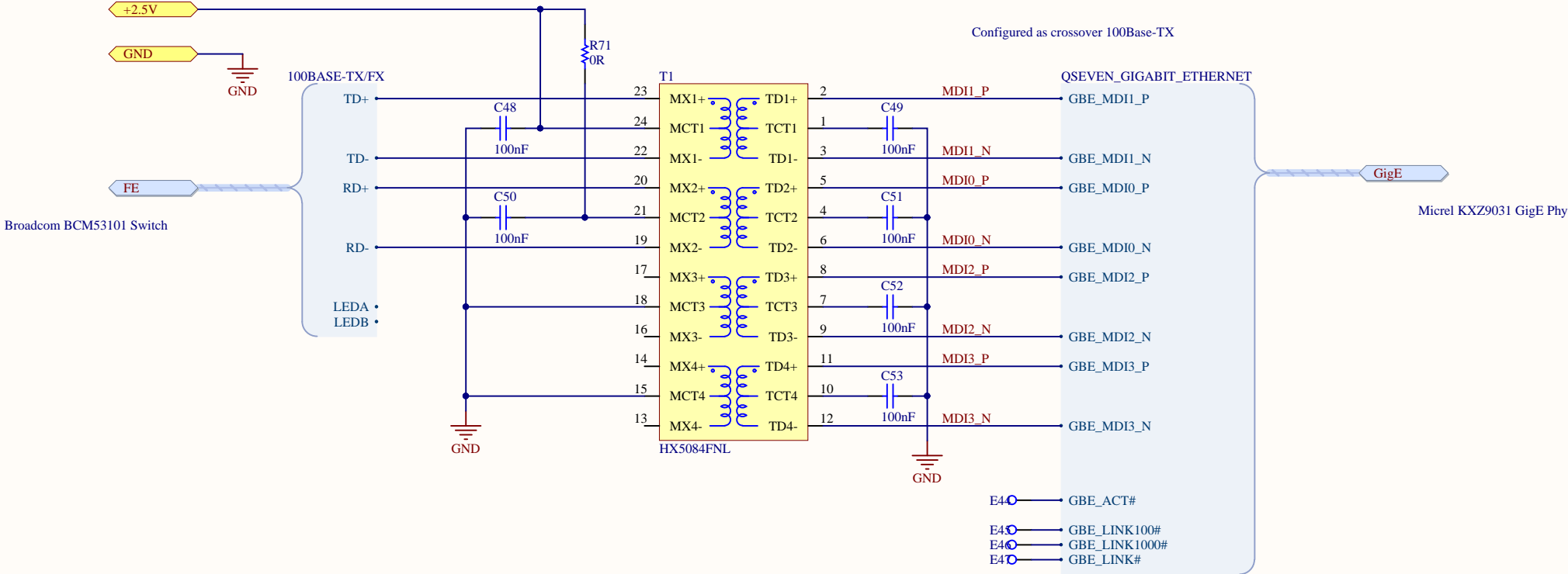
The AIO module standoff height should be 0.250 inches (6.35 mm).







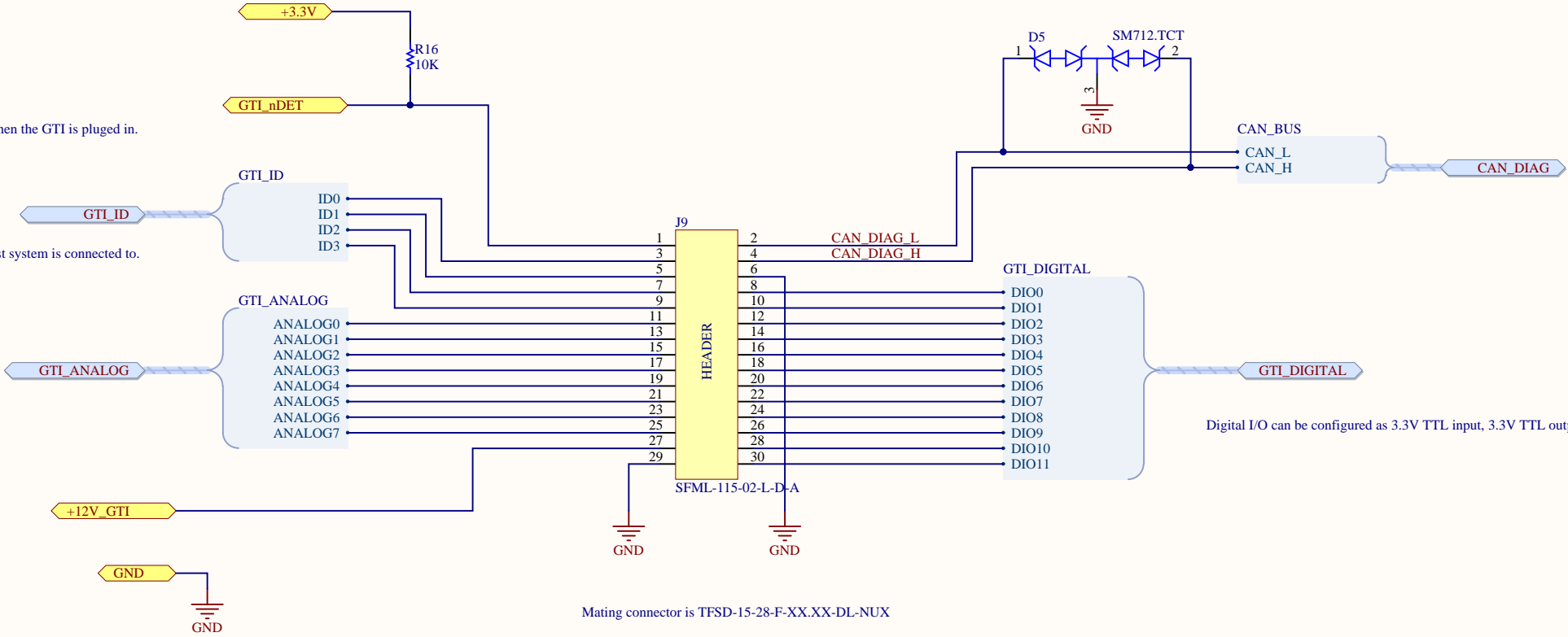




GTI_nDET will be tied to GND by the GTI system.
This signal can be used by the TMS570 to detect when the GTI is plugged in.

GTI_ID determines the type of board the ground test system is connected to.
Pins should be GND (0) or Floating (1).
No board connected = 1111

Analog input range is 0 to 15 V.
Rin = TBD (~100 to 500 kOhms)



Digital I/O can be configured as 3.3V TTL input, 3.3V TTL output, or open-collector output.

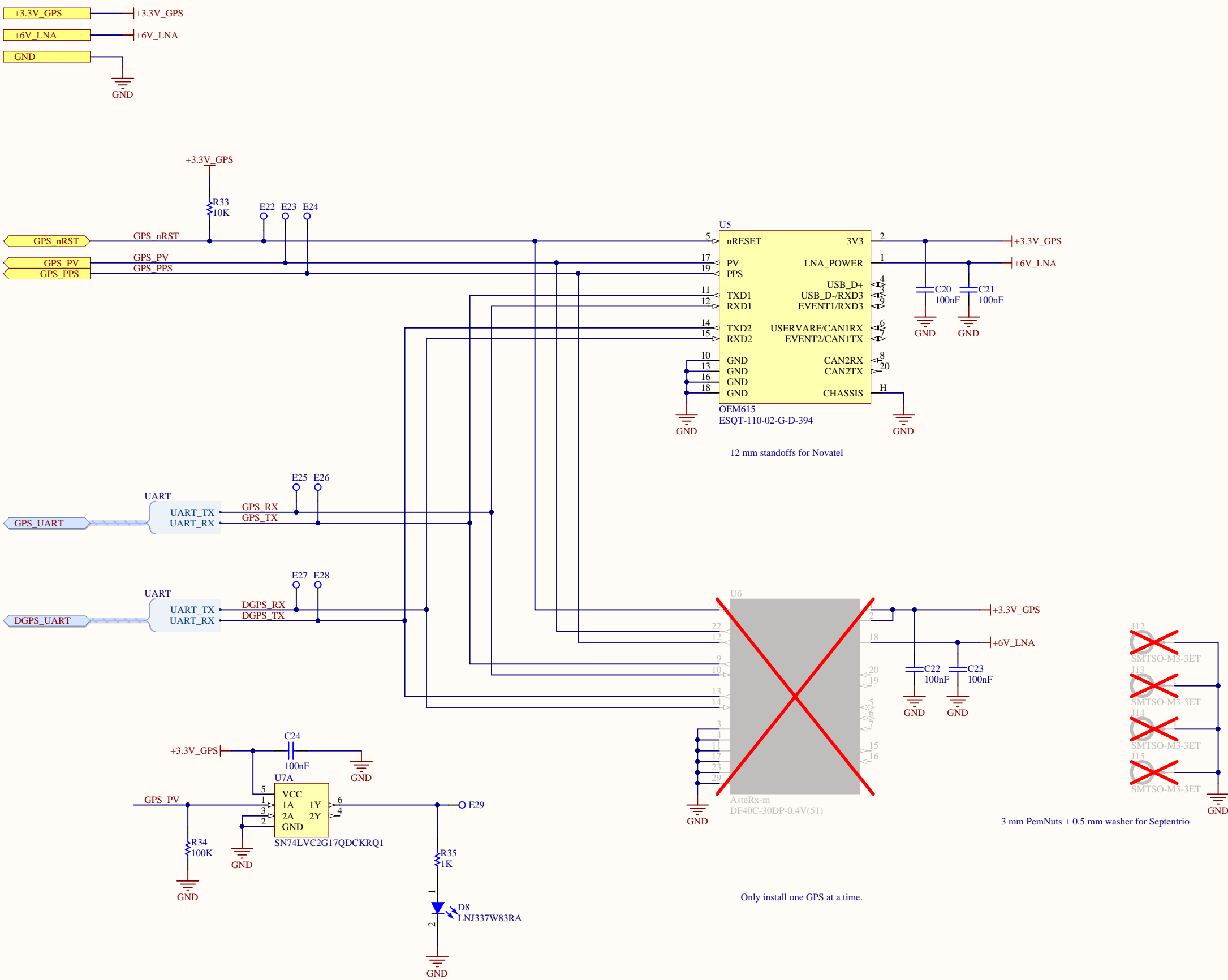
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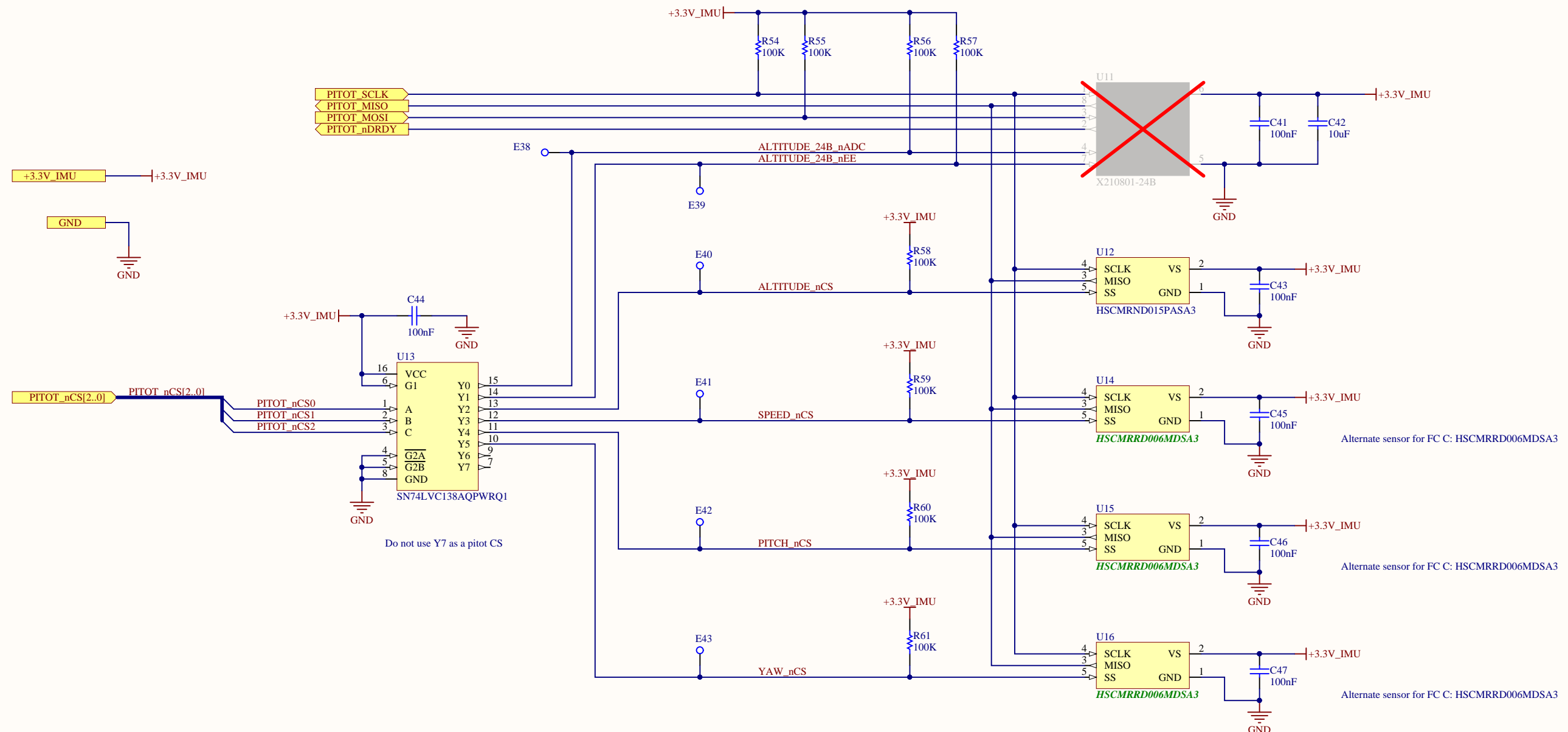
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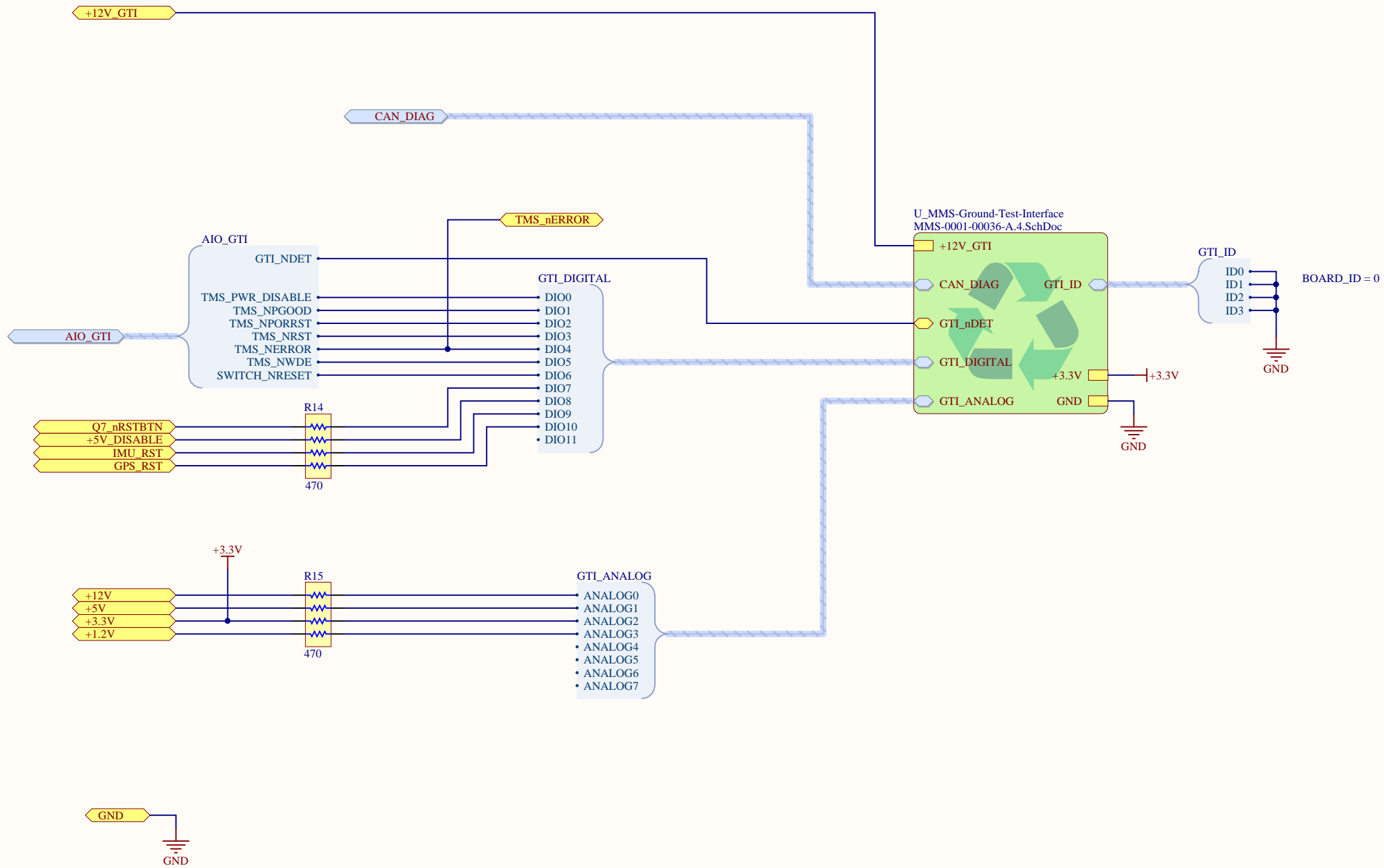
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Author: **EAC** File: **MMS-0001-00036-A.4.SchDoc**

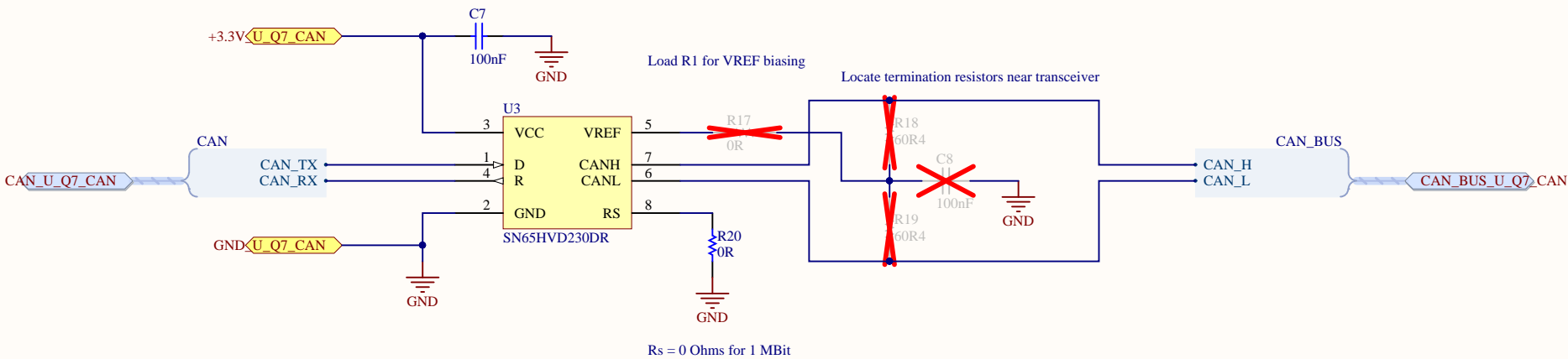
Makani Project
Google Inc.
2175 Monarch St.
Alameda CA, 94501
USA

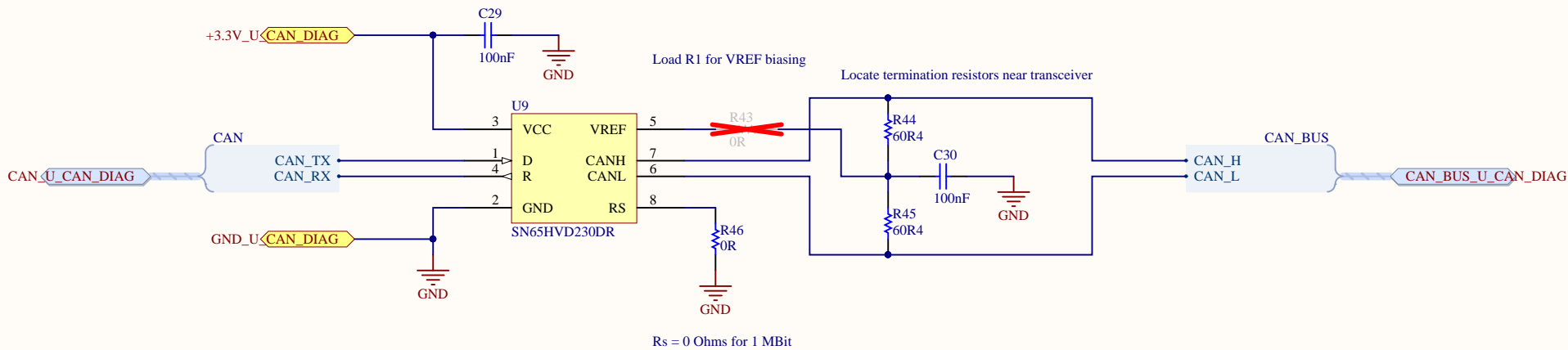












Vin = 8 V to 16 V (28 V max)

